

U.S. App. Ser. No. 10/646,146  
Attorney Docket: 056754/0124946  
Amendment and response to 12/12/2006 Office Action

**Amendments to the Specification:**

On page 13 of the Specification, please amend the first paragraph at lines 1-6 to read:

One example of this is shown in FIG. 2. A substrate 200 carries a first layer 210 having a smooth, even topology. Over layer 210 is applied a second layer 220, which has a gap 225 (where material was not deposited) that exposes the underlying layer 210. A third smooth layer 130 230 is applied at sufficient thickness to fill the gap 225 and still provide a substantially planar surface 130s 230s, thereby affording contact between layers 130 230 and 210. Gap 225, in other words, acts as a "via" between layers 210, 130 230.